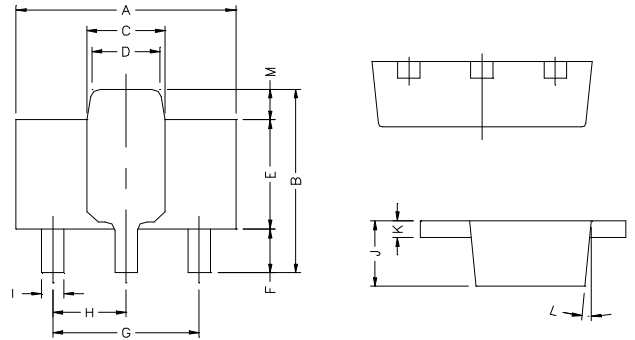


RoHS Compliant Product

## Description

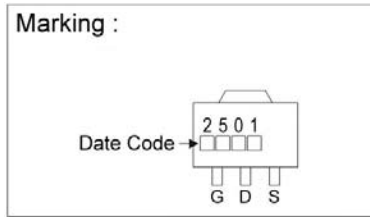
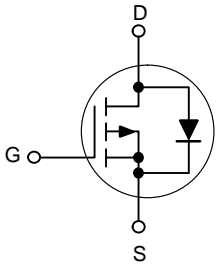
The SGM2301 provides the designer with the best combination of fast switching, low on-resistance and cost-effectiveness. The SOT-89 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage and battery power applications.

## SOT-89



## Features

- \* Surface Mount Device
- \* Simple Drive Requirement



| REF. | Millimeter |      | REF. | Millimeter |      |
|------|------------|------|------|------------|------|
|      | Min.       | Max. |      | Min.       | Max. |
| A    | 4.4        | 4.6  | G    | 3.00       | REF. |
| B    | 4.05       | 4.25 | H    | 1.50       | REF. |
| C    | 1.50       | 1.70 | I    | 0.40       | 0.52 |
| D    | 1.30       | 1.50 | J    | 1.40       | 1.60 |
| E    | 2.40       | 2.60 | K    | 0.35       | 0.41 |
| F    | 0.89       | 1.20 | L    | 5° TYP.    |      |
|      |            |      | M    | 0.70 REF.  |      |

## Absolute Maximum Ratings

| Parameter  | Symbol                                | Ratings  | Unit |
|--|---------------------------------------|----------|------|
| Drain-Source Voltage                             | V <sub>DS</sub>                       | -20      | V    |
| Gate-Source Voltage                              | V <sub>GS</sub>                       | ±12      | V    |
| Continuous Drain Current <sup>3</sup>            | I <sub>D</sub> @T <sub>A</sub> =25 °C | -2.6     | A    |
| Continuous Drain Current <sup>3</sup>            | I <sub>D</sub> @T <sub>A</sub> =70 °C | -2.1     | A    |
| Pulsed Drain Current <sup>1,2</sup>              | I <sub>DM</sub>                       | -10      | A    |
| Total Power Dissipation                          | P <sub>D</sub> @T <sub>A</sub> =25 °C | 1.5      | W    |
| Linear Derating Factor                           |                                       | 0.012    | W/°C |
| Operating Junction and Storage Temperature Range | T <sub>j</sub> , T <sub>stg</sub>     | -55~+150 | °C   |

## Thermal Data

| Parameter  | Symbol             | Ratings | Unit |
|--|--------------------|---------|------|
| Thermal Resistance Junction-ambient <sup>3</sup> | R <sub>thj-a</sub> | 83.3    | °C/W |

### Electrical Characteristics( $T_j=25^\circ C$ Unless otherwise specified)

| Parameter   | Symbol                      | Min. | Typ. | Max.      | Unit          | Test Condition   |
|---|-----------------------------|------|------|-----------|---------------|--|
| Drain-Source Breakdown Voltage                    | $BV_{DSS}$                  | -20  | -    | -         | V             | $V_{GS}=0V, I_D=-250\mu A$   |
| Breakdown Voltage Temp. Coefficient               | $\Delta BV_{DS}/\Delta T_j$ | -    | -0.1 | -         | V/ $^\circ C$ | Reference to $25^\circ C, I_D=-1mA$  |
| Gate Threshold Voltage                            | $V_{GS(th)}$                | -0.5 | -    | -         | V             | $V_{DS}=V_{GS}, I_D=-250\mu A$   |
| Gate-Source Leakage Current                       | $I_{GSS}$                   | -    | -    | $\pm 100$ | nA            | $V_{GS}=\pm 12V$   |
| Drain-Source Leakage Current ( $T_j=25^\circ C$ ) | $I_{DSS}$                   | -    | -    | -1        | $\mu A$       | $V_{DS}=-20V, V_{GS}=0$  |
| Drain-Source Leakage Current ( $T_j=70^\circ C$ ) |                             | -    | -    | -10       | $\mu A$       | $V_{DS}=-16V, V_{GS}=0$  |
| Static Drain-Source On-Resistance <sup>2</sup>    | $R_{DS(ON)}$                | -    | -    | 200       | m $\Omega$    | $V_{GS}=-10V, I_D=-2.6A$   |
|   |                             | -    | -    | 250       |               | $V_{GS}=-4.5V, I_D=-2A$  |
|   |                             | -    | -    | 300       |               | $V_{GS}=-2.5V, I_D=-1A$  |
| Total Gate Charge <sup>2</sup>                    | $Q_g$                       | -    | 5.2  | 10        | nC            | $I_D=-2.8A$<br>$V_{DS}=-6.0V$<br>$V_{GS}=-5.0V$                                |
| Gate-Source Charge                                | $Q_{gs}$                    | -    | 1.36 | -         |               |  |
| Gate-Drain ("Miller") Charge                      | $Q_{gd}$                    | -    | 0.6  | -         |               |  |
| Turn-on Delay Time <sup>2</sup>                   | $T_{d(ON)}$                 | -    | 5.2  | -         | nS            | $V_{DS}=-15V$<br>$I_D=-1A$<br>$V_{GS}=-10V$<br>$R_G=6\Omega$<br>$R_D=15\Omega$ |
| Rise Time   | $T_r$                       | -    | 9.7  | -         |               |  |
| Turn-off Delay Time                               | $T_{d(OFF)}$                | -    | 19   | -         |               |  |
| Fall Time   | $T_f$                       | -    | 29   | -         |               |  |
| Input Capacitance                                 | $C_{iss}$                   | -    | 295  | -         | pF            | $V_{GS}=0V$<br>$V_{DS}=-6V$<br>$f=1.0MHz$                                      |
| Output Capacitance                                | $C_{oss}$                   | -    | 170  | -         |               |  |
| Reverse Transfer Capacitance                      | $C_{rss}$                   | -    | 65   | -         |               |  |
| Forward Transconductance                          | $G_{fs}$                    | -    | 4.4  | -         | S             | $V_{DS}=-5V, I_D=-2.6A$  |

### Source-Drain Diode

| Parameter                                       | Symbol   | Min. | Typ. | Max. | Unit | Test Condition                         |
|---|----------|------|------|------|------|--|
| Forward On Voltage <sup>2</sup>                 | $V_{SD}$ | -    | -    | -1.2 | V    | $I_S=-1.6A, V_{GS}=0V, T_j=25^\circ C$ |
| Continuous Source Current (Body Diode)          | $I_S$    | -    | -    | -1   | A    | $V_D=V_G=0V, V_S=-1.2V$                |
| Pulsed Source Current (Body Diode) <sup>1</sup> | $I_{SM}$ | -    | -    | -10  | A    |  |

Notes: 1.Pulse width limited by Max. junction temperature.

2.Pulse width  $\leq 300\mu s$ , dutycycle  $\leq 2\%$ .

3.Surface mounted on FR4 board,  $t \leq 10sec$ .

## Characteristics Curve

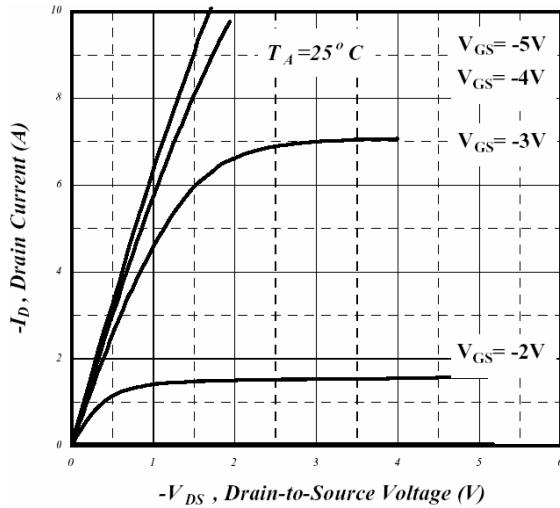


Fig 1. Typical Output Characteristics

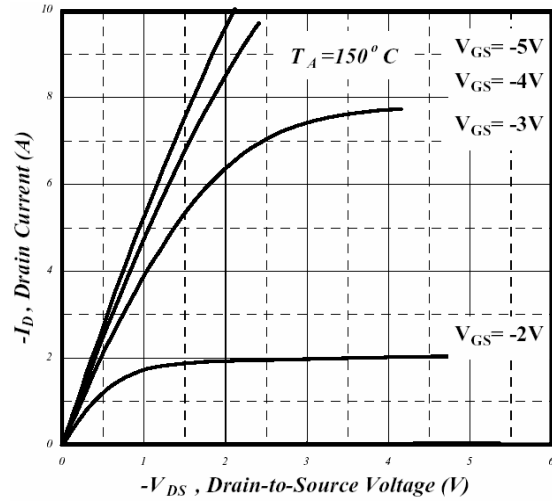


Fig 2. Typical Output Characteristics

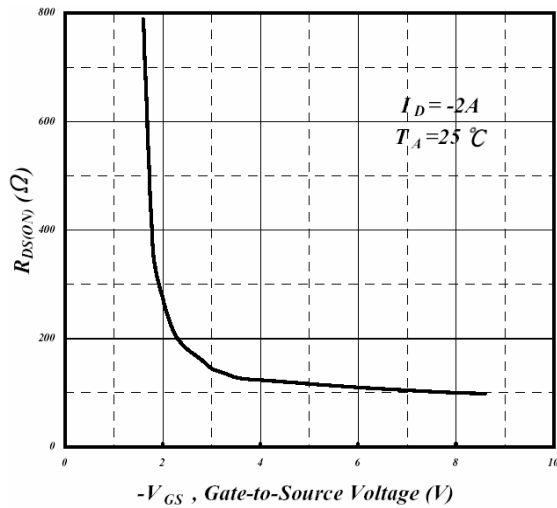


Fig 3. On-Resistance v.s. Gate Voltage

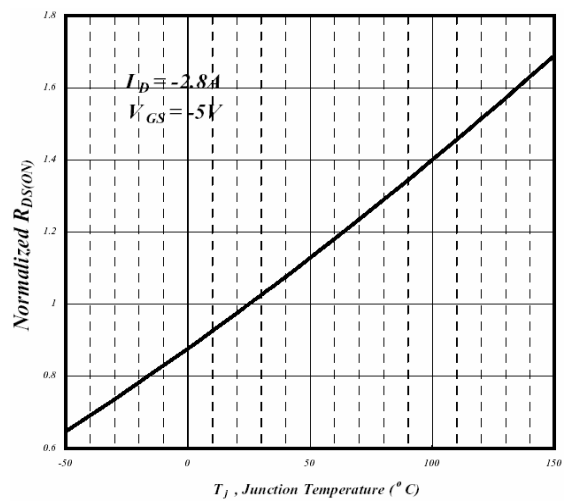


Fig 4. Normalized On-Resistance v.s. Junction Temperature

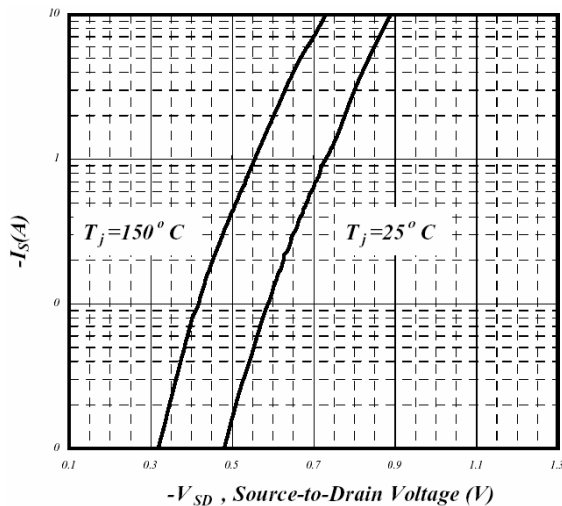


Fig 5. Forward Characteristics of Reverse Diode

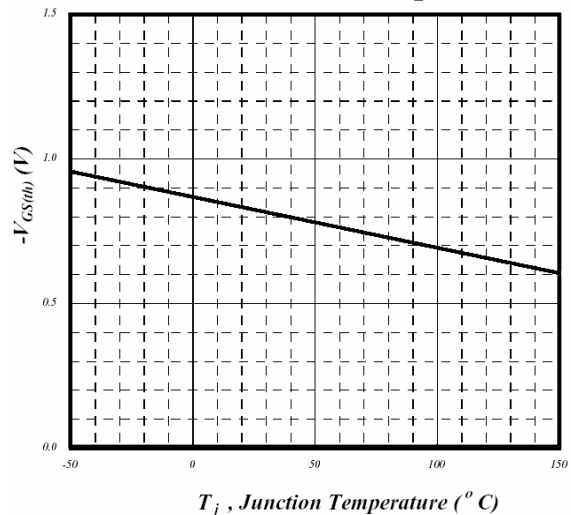


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

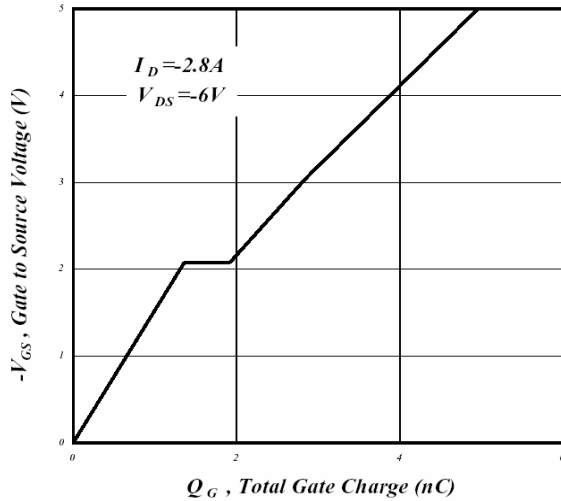


Fig 7. Gate Charge Characteristics

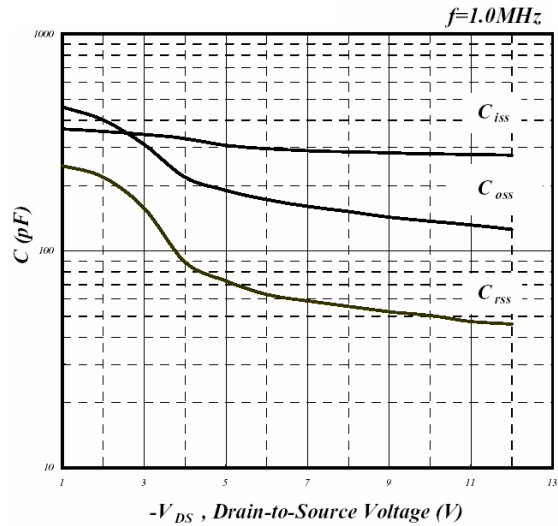


Fig 8. Typical Capacitance Characteristics

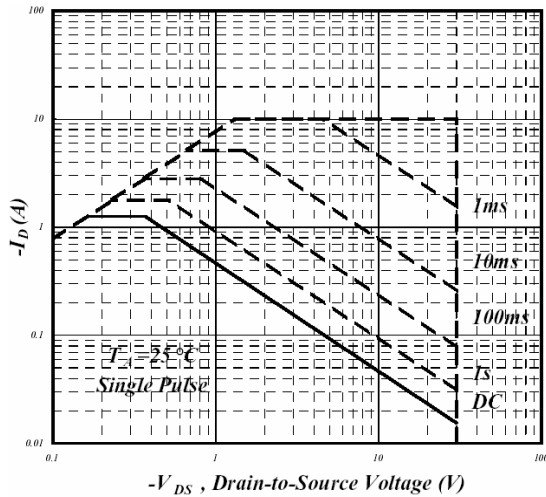


Fig 9. Maximum Safe Operating Area

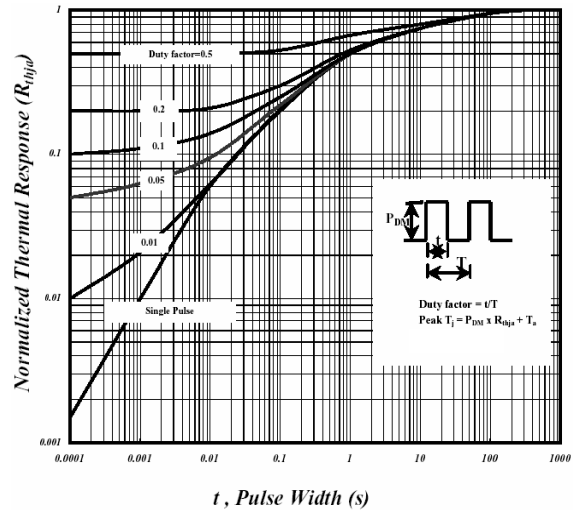


Fig 10. Effective Transient Thermal Impedance

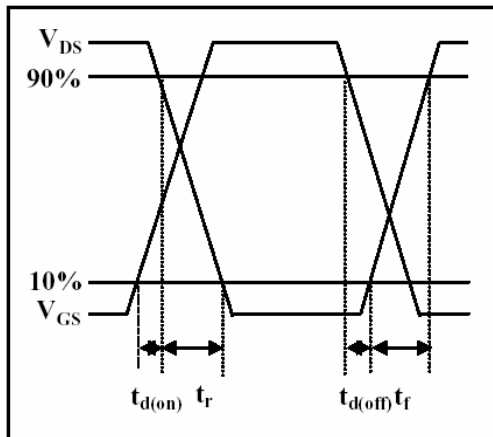


Fig 11. Switching Time Waveform

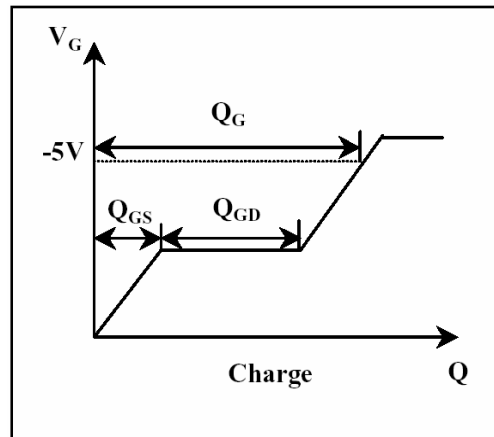


Fig 12. Gate Charge Waveform